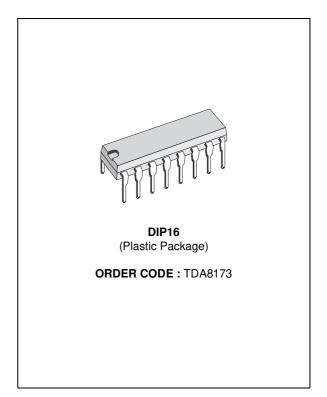


TDA8173

TV VERTICAL DEFLECTION OUTPUT CIRCUIT

- POWER AMPLIFIER
- FLYBACK GENERATOR
- THERMAL PROTECTION
- REFERENCE VOLTAGE



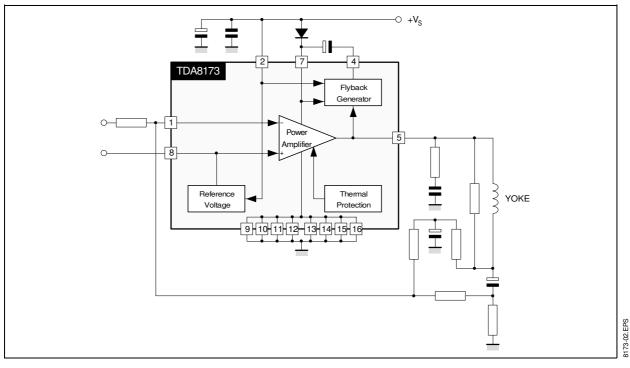
DESCRIPTION

The TDA8173 is a monolithic integrated circuit in POWERDIP package. It is a high efficiency power booster for direct driving of vertical windings of TV yokes. It is intended for use in Color and B & W television sets as well as in monitors, and displays.

PIN CONNECTIONS (top view)

INVERTING INPUT V _{S1} V _{S1} N.C. N.C. FLYBACK SENSE OUTPUT N.C. OUTPUT SUPPLY REFERENCE VOLTAGE	1 16 2 15 3 14 4 13 5 12 6 11 7 10 8 9

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
Vs	Supply Voltage (pin 2)	35	V	
V5	Flyback Peak Voltage	60	V	
V4	Voltage at Pin 4	+ Vs		
$V_1,\ V_8$	Amplifier Input Voltage	+ Vs - 0.5	V	
lo	Output Peak Current (non repetitive, t = 2 ms)	2.5	Α	
lo	Output Peak Current at f = 50 or 60 Hz, $t \le 10 \ \mu s$	3	Α	
lo	Output Peak Current at f = 50 or 60 Hz, t > 10 μs	2	Α	
I 4	Pin 4 DC Current at $V_5 < V_2$	100	mA	
I ₄	Pin 4 Peak to Peak Flyback Current at f = 50 or 60 Hz, $t_{fly} \le 1.5$ ms	3	Α	
P _{tot}	Total Power Dissipation at T _{case} = 60 °C	6	W	
T _{stg} , T _j	Storage and Junction Temperature	- 40 to 150	°C	

THERMAL DATA

Symbol	Parameter	Value	Unit	
Rth (j–c)	Thermal Resistance Junction-case Max.	15	°C/W	02.TBI
R _{th (j–a)}	Thermal Resistance Junction-ambient Max.	70	°C/W	8173-0

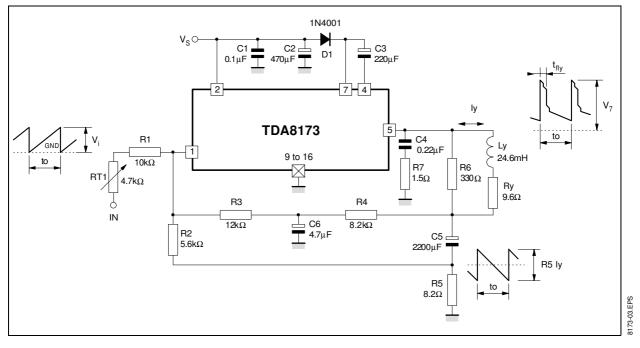


ELECTRICAL CHARACTERISTICS

(refer to the test circuits, $V_S = 35V$, $T_{amb} = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
l ₂	Pin 2 Quiescent Current	$I = 0, I_5 = 0$		8	16	mA
I ₇	Pin 7 Quiescent Current	$I = 0, I_5 = 0$		16	36	mA
I ₁	Amplifier Input Bias Current	$V_1 = 1 V$		- 0.1	- 1	μA
V _{4L}	Pin 4 Saturation Voltage to GND	l ₄ = 20 mA		1		V
V ₅	Quiescent Output Voltage	V_s = 35 V, R_a = 39 k Ω		18		V
V_{5L}	Output Saturation Voltage to GND	I ₅ = 1.2 A		1	1.4	V
		I ₅ = 0.7 A		0.7	1	V
V_{5H}	Output Saturation Voltage to Supply	– I ₅ = 1.2 A		1.6	2.2	V
		$-I_5 = 0.7 \text{ A}$		1.3	1.8	V
Tj	Junction Temperature for Thermal Shut Down			140		°C
V ₈	Reference Voltage			2.2		V
$\frac{\Delta V_8}{\Delta V_S}$	Reference Voltage Drift versus Supply Voltage	$V_s = 15 \text{ to } 30 \text{ V}$		1	2	mV

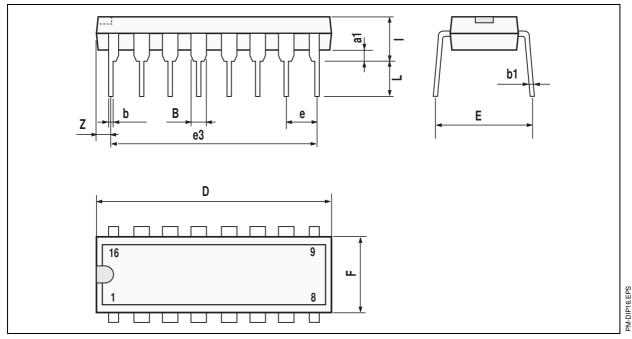
TEST CIRCUITS





PACKAGE MECHANICAL DATA

16 PINS - PLASTIC DIP



Dimensions		Millimeters			Inches	
Dimensions	Min.	Тур.	Max.	Min.	Тур.	Max.
a1	0.51			0.020		
В	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
i			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050

Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No licence is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

DIP16.TBL

© 1994 SGS-THOMSON Microelectronics - All Rights Reserved

Purchase of I²C Components of SGS-THOMSON Microelectronics, conveys a license under the Philips I²C Patent. Rights to use these components in a I²C system, is granted provided that the system conforms to the I²C Standard Specifications as defined by Philips.

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - China - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco The Netherlands - Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.



This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.